

### **1. General description**

Planar passivated Silicon Controlled Rectifier (SCR) in IITO220 internally insulated plastic package intended for use in applications requiring very high inrush current capability, high thermal cycling performance and high junction temperature capability ( $T_{i(max)} = 150$  °C).

### 2. Features and benefits

- High junction operating temperature capability (T<sub>i(max)</sub> = 150 °C)
- High bidirectional blocking voltage capability
- Very high current surge capability
- High thermal cycling performance
- Planar passivated for voltage ruggedness and reliability
- Internally insulated package
- Isolated mounting base with 2500 V (RMS) isolation

## **3. Applications**

- · Protection circuit in Power Supplies for Consumer / Industrial / Medical Equipment
- Capacitive Discharge Ignition (CDI)
- Crowbar protection
- Inrush protection
- Motor control
- Voltage regulation

### 4. Quick reference data

Table 1. Quic	k reference data						
Symbol	Parameter	Conditions	Values	Unit			
Absolute ma	Absolute maximum rating						
V <sub>DRM</sub>	repetitive peak off-state voltage		600	V			
I <sub>T(RMS)</sub>	RMS on-state current	half sine wave; T <sub>mb</sub> ≤ 116 °C; <u>Fig. 1; Fig. 2; Fig. 3</u>	20	A			
I <sub>TSM</sub>	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 10 ms; Fig. 4; Fig. 5	230	A			
		half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 8.3 ms	253	А			
T <sub>j</sub>	junction temperature		150	°C			

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static characteristics							
I <sub>GT</sub>	gate trigger current	$V_{D}$ = 12 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 25 °C; <u>Fig. 7</u>		-	5	32	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; <u>Fig. 9</u>		-	-	40	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 32 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>		-	1.2	1.5	V
Dynamic	Dynamic characteristics						
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 402 V; T <sub>j</sub> = 150 °C; (V <sub>DM</sub> = 67% of V <sub>DRM</sub> ); exponential waveform; gate open circuit		1000	-	-	V/µs

# 5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	$\square$	. 51 //
2	Α	anode		A H K G
3	G	gate		sym037
mb	n.c.	mounting base; isolated		

# 6. Ordering information

Table 3. Ordering information						
Type number	Package	Orderable part number	Packing	Small packing	Package	Package
	name		method	quantity	version	issue date
TYN20Y-600T	IITO220	TYN20Y-600TQ	Tube	50	IITO220E	15-Dec-2017

## 7. Marking

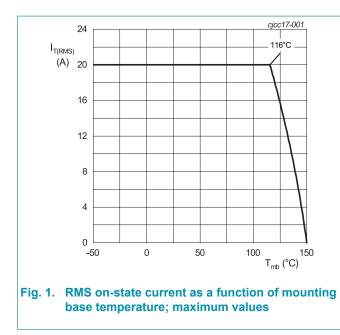
Table 4. Marking codes	
Type number	Marking codes
TYN20Y-600T	TYN20Y 600T

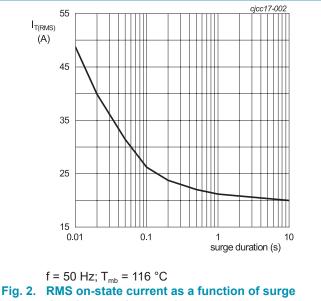
# 8. Limiting values

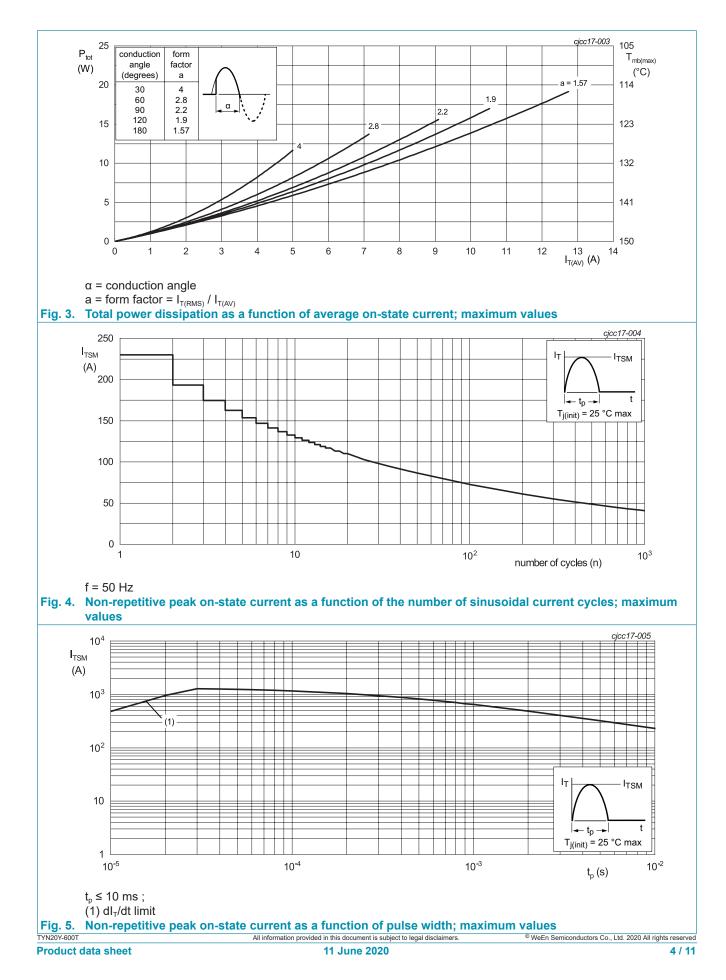
### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V <sub>DRM</sub>	repetitive peak off-state voltage		600	V
V <sub>RRM</sub>	repetitive peak reverse voltage		600	V
I <sub>T(AV)</sub>	average on-state current	half sine wave; $T_{mb} \le 116 \text{ °C}$	12.7	А
I <sub>T(RMS)</sub>	RMS on-state current	half sine wave; T <sub>mb</sub> ≤ 116 °C; <u>Fig. 1; Fig. 2; Fig. 3</u>	20	A
I <sub>TSM</sub>	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 10 ms; Fig. 4; Fig. 5	230	A
		half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 8.3 ms	253	A
l <sup>2</sup> t	l <sup>2</sup> t for fusing	t <sub>p</sub> = 10 ms; sine wave	265	A <sup>2</sup> s
dl <sub>T</sub> /dt	rate of rise of on-state current	I <sub>G</sub> = 70 mA	150	A/µs
I <sub>GM</sub>	peak gate current		5	A
V <sub>RGM</sub>	peak reverse gate voltage		5	V
P <sub>GM</sub>	peak gate power		20	W
P <sub>G(AV)</sub>	average gate power	over any 20 ms period	1	W
T <sub>stg</sub>	storage temperature		-40 to 150	°C
Tj	junction temperature		150	°C

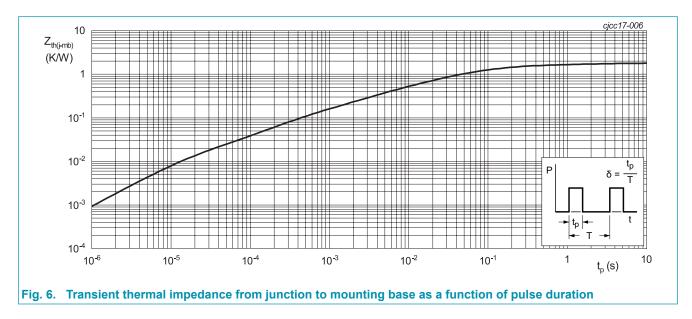






Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	<u>Fig. 6</u>	-	-	1.8	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	60	-	K/W



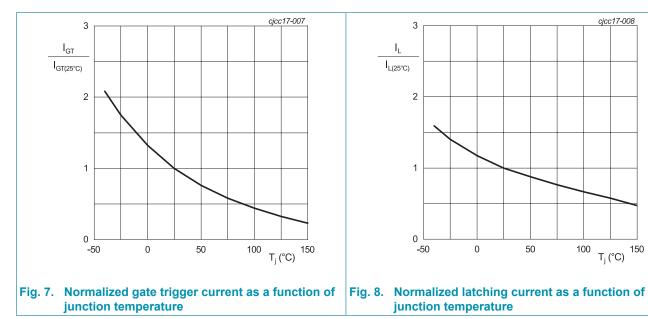


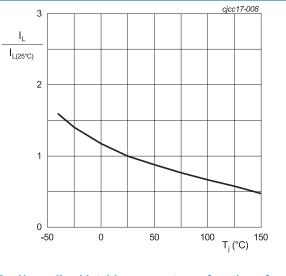
# **10. Isolation characteristics**

Table 7. Isolation characteristics							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{isol(RMS)}$	RMS isolation voltage	50 Hz $\leq$ f $\leq$ 60 Hz; RH $\leq$ 65 %; from all pins to external heatsink; sinusoidal waveform; clean and dust free		-	-	2500	V
C <sub>isol</sub>	isolation capacitance	from cathode to external heatsink		-	10	-	pF

## **11. Characteristics**

lable 8. Ch	aracteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
I <sub>GT</sub>	gate trigger current	$V_{D}$ = 12 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 25 °C; <u>Fig. 7</u>	-	5	32	mA
I <sub>L</sub>	latching current	$V_{\rm D}$ = 12 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 25 °C; <u>Fig. 8</u>	-	-	60	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; <u>Fig. 9</u>	-	-	40	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 32 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>	-	1.2	1.5	V
V <sub>GT</sub>	gate trigger voltage	$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T}_{j} = 25 \text{ °C};$ Fig. 11	-	0.7	1	V
		V <sub>D</sub> = 400 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 150 °C	0.2	0.4	-	V
I <sub>D</sub>	off-state current	V <sub>D</sub> = 600 V; T <sub>j</sub> = 150 °C	-	-	1	mA
I <sub>R</sub>	reverse current	V <sub>D</sub> = 600 V; T <sub>j</sub> = 150 °C	-	-	1	mA
Dynamic c	haracteristics	·				
dV <sub>D</sub> /dt	rate of rise of off-state voltage			-	-	V/µs
t <sub>gt</sub>	gate-controlled turn-on time	$I_{TM} = 20 \text{ A}; V_D = 600 \text{ V}; I_G = 100 \text{ mA};$ $(dI_G/dt)_M = 5 \text{ A}/\mu\text{s}; T_j = 25 \text{ °C}$		2	-	μs
t <sub>q</sub>	commutated turn-off time			70	-	μs







### WeEn Semiconductors

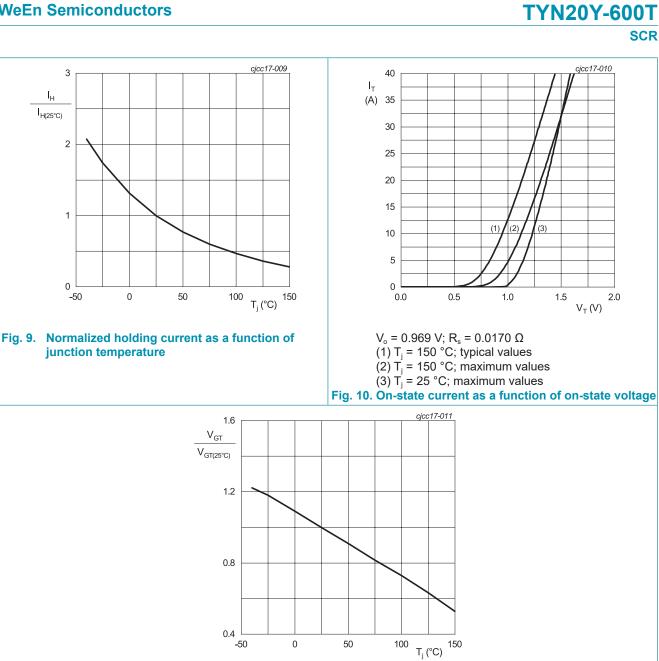
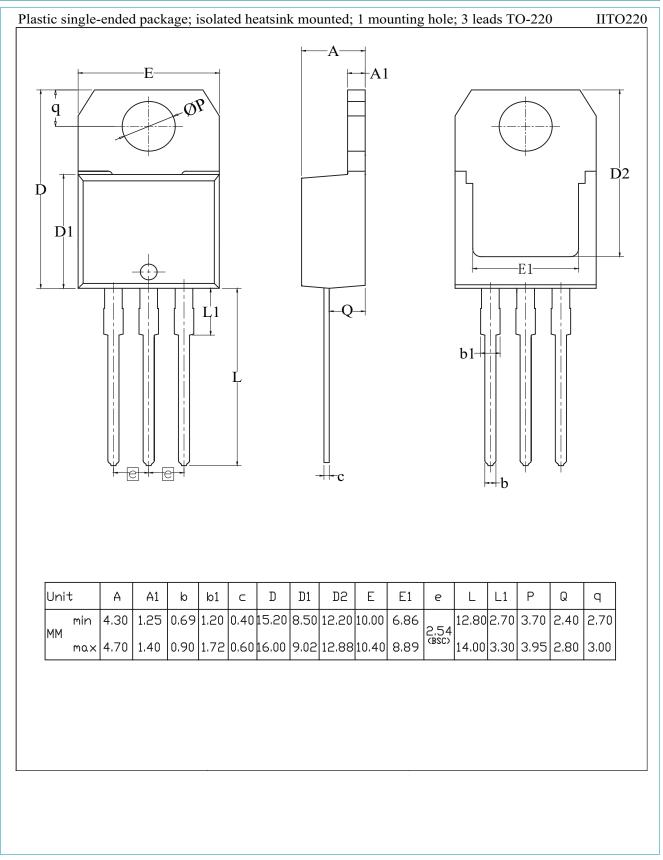


Fig. 11. Normalized gate trigger voltage as a function of junction temperature

## 12. Package outline



# 13. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- The term 'short data sheet' is explained in section "Definitions". [2]
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